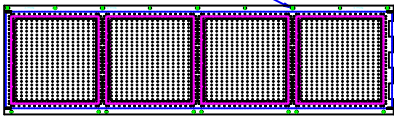


框架传送方向 (装片):  
L/F Direction (D/A):

椭圆孔



注意: 基岛全镀银

实物图:  
Chip photo:

特殊说明 Special Instructions :

DFN8L(2×3×0.5-P0.5)(68×41mil<sup>2</sup>)(4 block)  
(1720×1050um<sup>2</sup>)